



Si6562CDY vs. Si6562DY

Description: N- and P-Channel, 20-V (D-S) MOSFET

Package: TSSOP-8

Pin Out: Identical

Part Number Replacements: Si6562CDY-T1-GE3 replaces Si6562DY-T1-GE3

ABSOLUTE MAXIMUM RATINGS $T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted					
PARAMETER		SYMBOL	Si6562CDY	Si6562DY	UNIT
Drain-Source Voltage		V_{DS}	N-Ch	20	V
			P-Ch	-20	
Gate-Source Voltage		V_{GS}	N-Ch	± 12	V
			P-Ch		
Continuous Drain Current	$T_A = 25\text{ }^\circ\text{C}$	I_D	N-Ch	5.7	A
			P-Ch	-5.1	
	$T_A = 70\text{ }^\circ\text{C}$		N-Ch	4.5	
			P-Ch	-4.1	
Pulsed Drain Current		I_{DM}	N-Ch	30	A
			P-Ch	-30	
Continuous Source Current (MOSFET Diode Conduction)		I_S	N-Ch	0.9	W
			P-Ch	-1.0	
Power Dissipation	$T_A = 25\text{ }^\circ\text{C}$	P_D	N-Ch	1.1	1
			P-Ch	2	
	$T_A = 70\text{ }^\circ\text{C}$		N-Ch	0.7	0.64
			P-Ch	0.76	
Operating Junction and Storage Temperature Range		T_J and T_{stg}	-55 to 150	-55 to 150	$^\circ\text{C}$
Maximum Junction-to-Ambient		R_{thJA}	N-Ch	110	$^\circ\text{C/W}$
			P-Ch	105	

SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted										
PARAMETER	SYMBOL	Si6562CDY			Si6562DY			UNIT		
		MIN.	TYP.	MAX.	MIN.	TYP.	MAX.			
Static										
Gate-Threshold Voltage	$V_{GS(th)}$	N-Ch	0.6		1.5	0.6		NS	V	
		P-Ch	-0.6		-1.5	-0.6		NS		
Gate-Body Leakage	I_{GSS}	N-Ch			± 100			± 100	nA	
		P-Ch			± 100			± 100		
Zero Gate Voltage Drain Current	I_{DSS}	N-Ch			1			1	μA	
		P-Ch			-1			-1		
On-State Drain Current	$V_{GS} = 4.5\text{ V}$	$I_{D(on)}$	N-Ch	30		30			A	
	$V_{GS} = -4.5\text{ V}$		P-Ch	-30		-30				
Drain-Source On-Resistance	$V_{GS} = 4.5\text{ V}$	$R_{DS(on)}$	N-Ch		0.018	0.022		0.023	0.030	Ω
	$V_{GS} = -4.5\text{ V}$		P-Ch		0.024	0.030		0.040	0.050	
	$V_{GS} = 2.5\text{ V}$		N-Ch		0.029	0.036		0.030	0.040	
	$V_{GS} = -2.5\text{ V}$		P-Ch		0.036	0.045		0.060	0.085	
Forward Transconductance	g_{fs}	N-Ch		17			20		S	
		P-Ch		22			10			
Diode Forward Voltage	V_{SD}	N-Ch		0.8	1.2		0.65	1.2	V	
		P-Ch		-0.8	-1.2		-0.72	-1.2		

Specification Comparison

Vishay Siliconix



SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted									
PARAMETER	SYMBOL	Si6562CDY			Si6562DY			UNIT	
		MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
Dynamic									
Total Gate Charge	Q_g	N-Ch		6.7	11		13	25	nC
		P-Ch		17	30		14.5	25	
Gate-Source Charge	Q_{gs}	N-Ch		1.8			3.0		
		P-Ch		3			3.5		
Gate-Drain Charge	Q_{gd}	N-Ch		0.9			3.3		
		P-Ch		5.5			3.5		
Gate Resistance	R_g	N-Ch		2			NS		
		P-Ch		6			NS		

Note

NS denotes not specified in original specification

Specification comparisons are supplied as a courtesy to compare two devices and do not constitute a commercial product datasheet or any guarantee of identical performance. Designers should refer to the appropriate datasheets of the same number for guaranteed specification limits.